

SB3T80

3.0AMPS. SCHOTTKY BARRIER RECTIFIERS

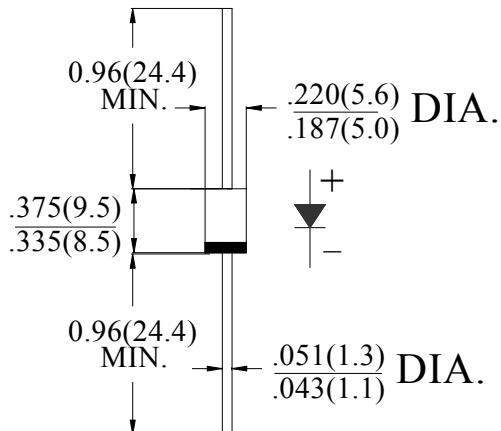
FEATURE

- . For surface mounted application
- . High current capability
- . Low forward voltage drop
- . Low power loss, high efficiency
- . High surge current capability
- . High temperature soldering guaranteed:
260°C/10 seconds at terminals.

MECHANICAL DATA

- . Terminal: Solder plated
- . Case: Molded with UL-94 Class V-0 recognized
Flame Retardant Epoxy (free halogen)
- . Polarity: color band denotes cathode

DO-27/DO-201AD



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	SYM BOL	SB3T80	units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	80	V
Maximum RMS Voltage	V_{RMS}	56	V
Maximum DC blocking Voltage	V_{DC}	80	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	80.0	A
Forward Voltage at 3.0A DC @ $T_A=25^\circ\text{C}$	$V_{F(MAX)}$	0.58	V
	$V_{F(TYPE)}$	0.52	
	$V_{F(MAX)}$	0.51	
Maximum DC Reverse Current @ $T_f=25^\circ\text{C}$ at rated DC blocking voltage @ $T_j=100^\circ\text{C}$	I_R	0.1	mA
		10.0	
Typical Junction Capacitance (Note1)	C_J	370	pF
Typical Thermal Resistance (Note2)	$R_{(JA)}$	45	°C/W
Storage Temperature	T_{STG}	-55 to +150	°C
Operating Junction Temperature	T_J	-55 to +150	°C

Note:

1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
2. Measured on P.C. Board with $0.2 \times 0.2''$ (5.0×5.0 mm) Copper Pad Areas.

RATING AND CHARACTERISTIC CURVES (SB3T80)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

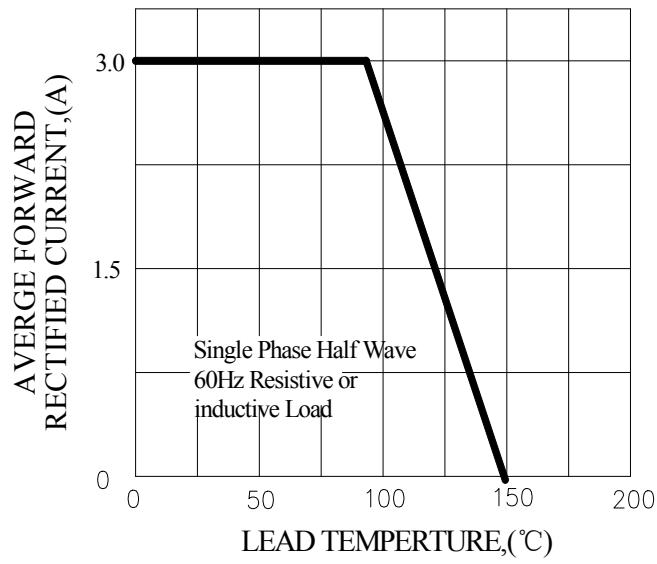


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

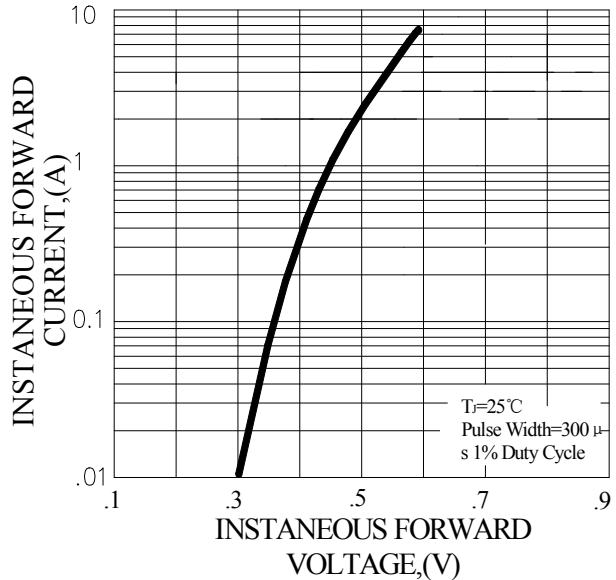


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

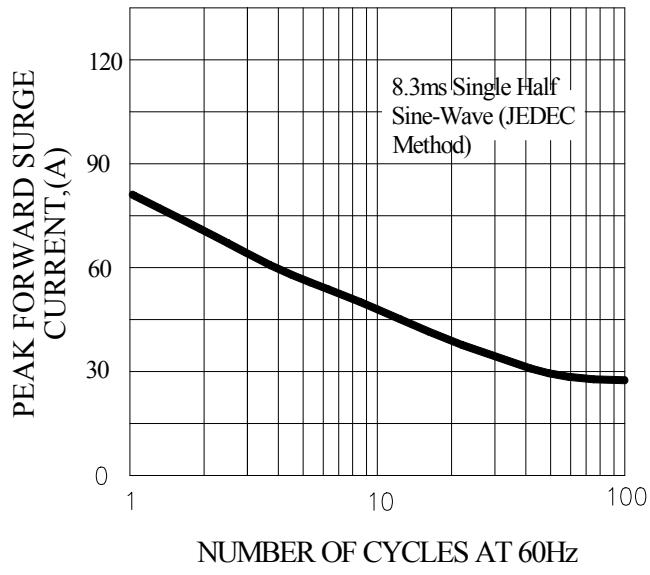
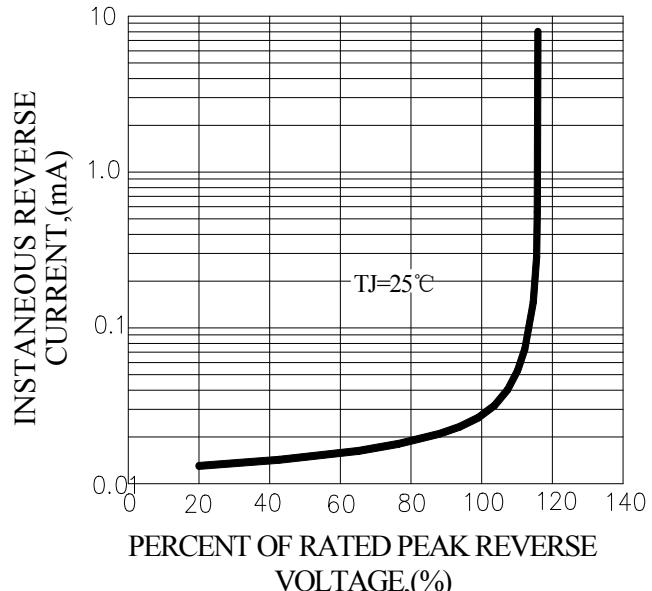
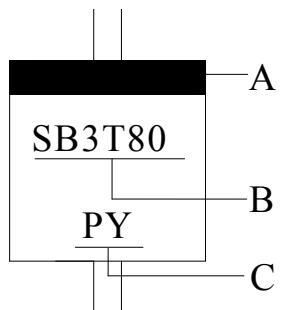


FIG.4-TYPICAL REVERSE CHARACTERISTICS



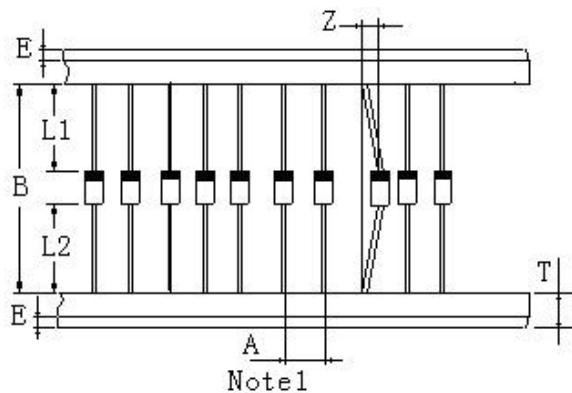
Marking and packaging illustration

1、Marking



SYMBOL	Explanation
A	Color Band Denotes Cathode
B	Product Name
C	Trademark

2、Packaging



ITEM	SYMBOL	SPECIFICATIONS (mm)	SPECIFICATIONS (inch)
Component alignment	Z	1.2max	0.048max
Tape width	T	6.0 ± 0.4	0.236 ± 0.016
Exposed adhesive	E	0.8max	0.032max
Body eccentricity	L1-L2	1.0max	0.040max
Component	A	10.0 ± 0.5	0.4 ± 0.02
Inner tap	B	52.0~53.5	2.05~2.11
NOTE:	Each component lead shall be sandwiched between tapes for a minimum of 2.5mm (0.1inch)		

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